



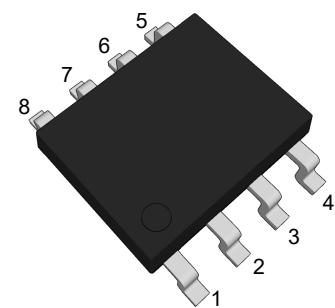
PJM08C40PA

N and P-Channel Complementary Power MOSFET

Product Summary

- N-Channel
- $V_{DS} = 40V, I_D = 8A$
- $R_{DS(on)} < 19m\Omega @ V_{GS} = 10V$
- $R_{DS(on)} < 29m\Omega @ V_{GS} = 4.5V$
- P-Channel
- $V_{DS} = -40V, I_D = -7A$
- $R_{DS(on)} < 35m\Omega @ V_{GS} = -10V$
- $R_{DS(on)} < 45m\Omega @ V_{GS} = -4.5V$

SOP-8



(Top View)

Features

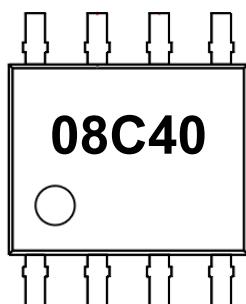
- Advanced Trench Technology
- 100% Avalanche Tested
- RoHS and Reach Compliant
- Halogen and Antimony Free
- Moisture Sensitivity Level 3

Pin	Description	Pin	Description
1	Source1	4	Gate2
2	Gate1	5,6	Drain2
3	Source2	7,8	Drain1

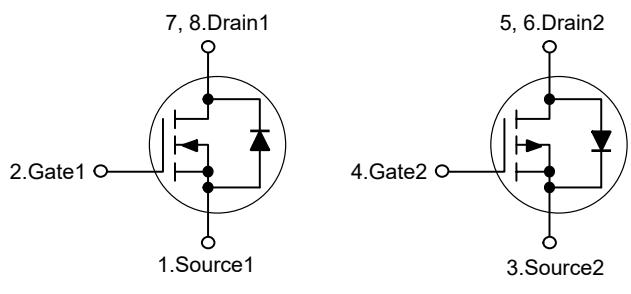
Application

- Power Management

Marking Code



Schematic Diagram



N-Channel

P-Channel



Absolute Maximum Ratings

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V_{DS}	40	-40	V
Gate-Source Voltage	V_{GS}	± 20		V
Drain Current-Continuous	I_D	8	-7	A
Drain Current-Pulsed ^{Note1}	I_{DM}	40	-30	A
Maximum Power Dissipation	P_D	2		W
Junction Temperature	T_J	150		°C
Storage Temperature Range	T_{STG}	-55 to +150		°C

Thermal Characteristics

Thermal Resistance, Junction-to-Ambient ^{Note2}	$R_{\theta JA}$	62.5	62.5	°C/W
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PJM08C30PA

N and P-Channel Complementary Power MOSFET

N-Channel

Electrical Characteristics

($T_a=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	40	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=40\text{V}, V_{GS}=0\text{V}$	--	--	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$	--	--	± 100	nA
Gate Threshold Voltage ^{Note3}	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	1.5	2	V
Drain-Source On-Resistance ^{Note3}	$R_{DS(\text{on})}$	$V_{GS}=10\text{V}, I_D=8\text{A}$	--	14	19	$\text{m}\Omega$
		$V_{GS}=10\text{V}, I_D=4\text{A}$	--	19	29	$\text{m}\Omega$
Forward Transconductance ^{Note3}	g_{FS}	$V_{DS}=5\text{V}, I_D=8\text{A}$	33	--	--	S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=20\text{V}, V_{GS}=0\text{V}, f=1\text{MHz}$	--	415	--	pF
Output Capacitance	C_{oss}		--	112	--	pF
Reverse Transfer Capacitance	C_{rss}		--	11	--	pF
Total Gate Charge	Q_g	$V_{DS}=20\text{V}, I_D=8\text{A}, V_{GS}=10\text{V}$	--	12	--	nC
Gate-Source Charge	Q_{gs}		--	3.2	--	nC
Gate-Drain Charge	Q_{gd}		--	3.1	--	nC
Switching Characteristics						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=15\text{V}, R_L=2.5\Omega$ $V_{GS}=10\text{V}, R_{GEN}=3\Omega$	--	4	--	nS
Turn-on Rise Time	t_r		--	3	--	nS
Turn-off Delay Time	$t_{d(off)}$		--	15	--	nS
Turn-off Fall Time	t_f		--	2	--	nS
Source-Drain Diode Characteristics						
Diode Forward Voltage ^{Note3}	V_{SD}	$V_{GS}=0\text{V}, I_S=8\text{A}$	--	0.8	1.2	V
Diode Forward Current ^{Note2}	I_S		--	--	8	A

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \leq 10$ sec.

3. Pulse Test: Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$



PJM08C40PA

N and P-Channel Complementary Power MOSFET

P-Channel

Electrical Characteristics

($T_a=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$-V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	40	--	--	V
Zero Gate Voltage Drain Current	$-I_{\text{DSS}}$	$V_{\text{DS}}=-40\text{V}, V_{\text{GS}}=0\text{V}$	--	--	1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{\text{GS}}=\pm20\text{V}, V_{\text{DS}}=0\text{V}$	--	--	±100	nA
Gate Threshold Voltage ^{Note3}	$-V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	1	1.5	2	V
Drain-Source On-Resistance ^{Note3}	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=-10\text{V}, I_{\text{D}}=-8\text{A}$	--	29	35	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-4\text{A}$	--	34	45	$\text{m}\Omega$
Forward Transconductance ^{Note3}	g_{FS}	$V_{\text{DS}}=-5\text{V}, I_{\text{D}}=-8\text{A}$	10	--	--	S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{\text{DS}}=-20\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	--	520	--	pF
Output Capacitance	C_{oss}		--	100	--	pF
Reverse Transfer Capacitance	C_{rss}		--	65	--	pF
Total Gate Charge	Q_g	$V_{\text{DS}}=-20\text{V}, I_{\text{D}}=-8\text{A}, V_{\text{GS}}=-10\text{V}$	--	13	--	nC
Gate-Source Charge	Q_{gs}		--	3.8	--	nC
Gate-Drain Charge	Q_{gd}		--	3.1	--	nC
Switching Characteristics						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=-20\text{V}, R_{\text{L}}=2.3\Omega$ $V_{\text{GS}}=-10\text{V}, R_{\text{GEN}}=6\Omega$	--	7.5	--	nS
Turn-on Rise Time	t_r		--	5.5	--	nS
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	19	--	nS
Turn-off Fall Time	t_f		--	7	--	nS
Source-Drain Diode Characteristics						
Diode Forward Voltage ^{Note3}	$-V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{s}}=-7\text{A}$	--	--	1.2	V
Diode Forward Current ^{Note2}	$-I_{\text{s}}$		--	--	7	A

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, $t \leq 10$ sec.

3. Pulse Test: Pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$

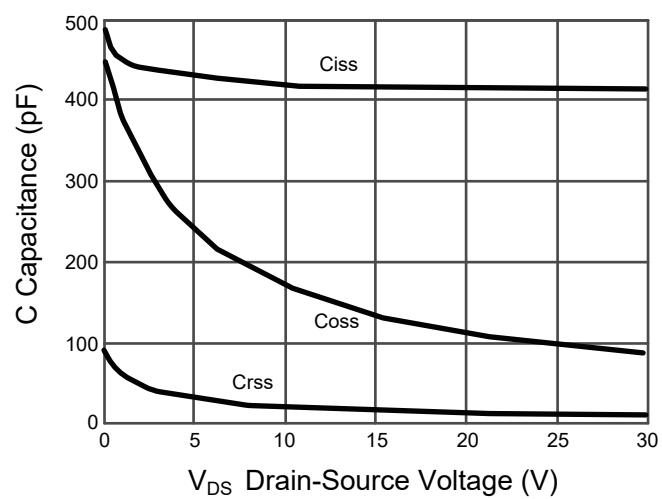
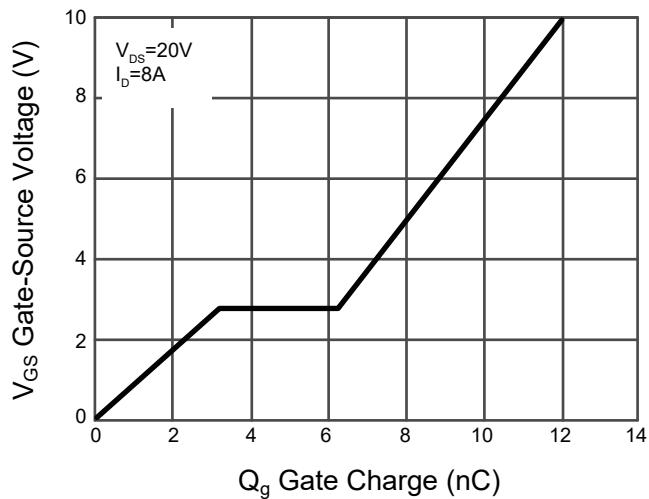
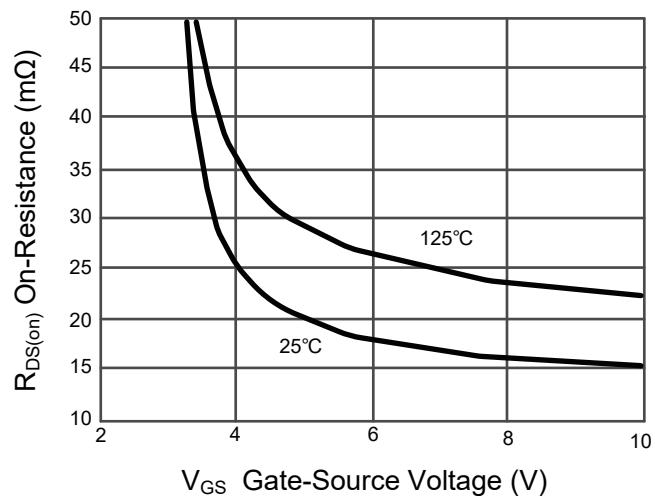
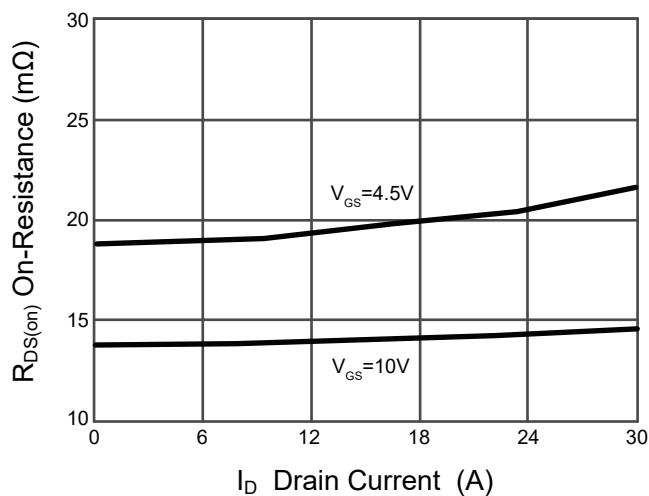
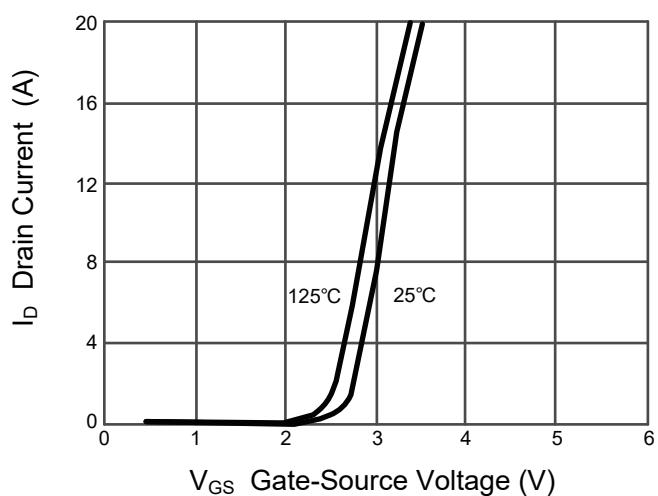
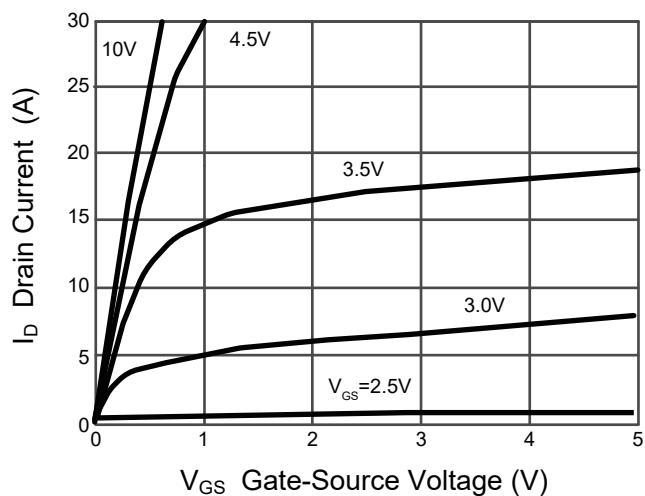


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N-Channel

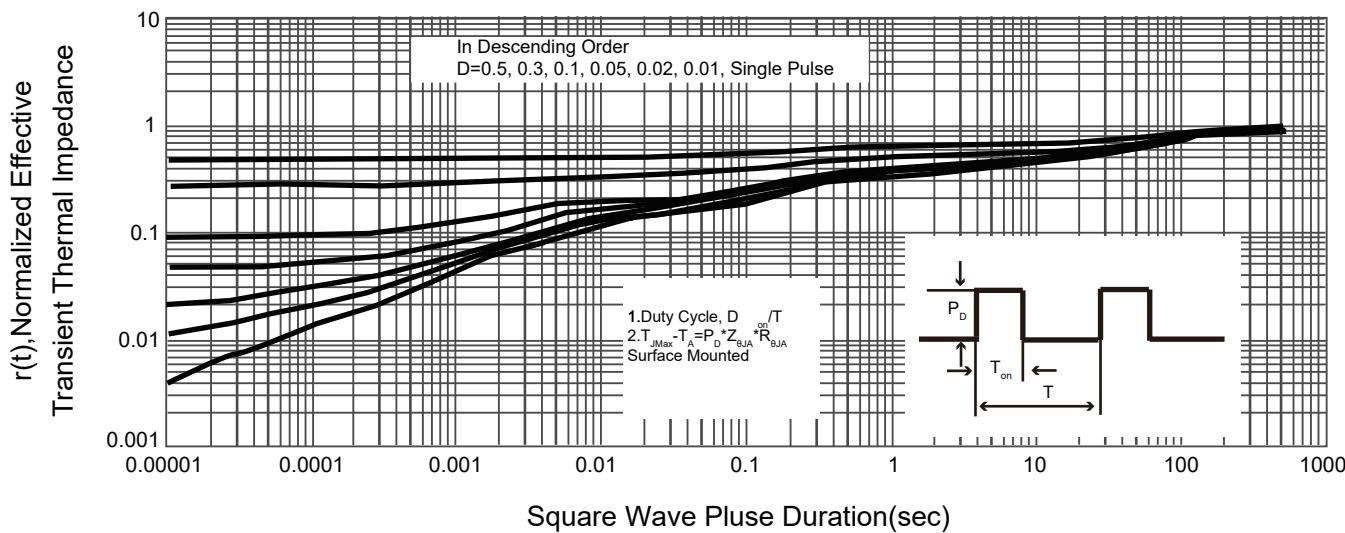
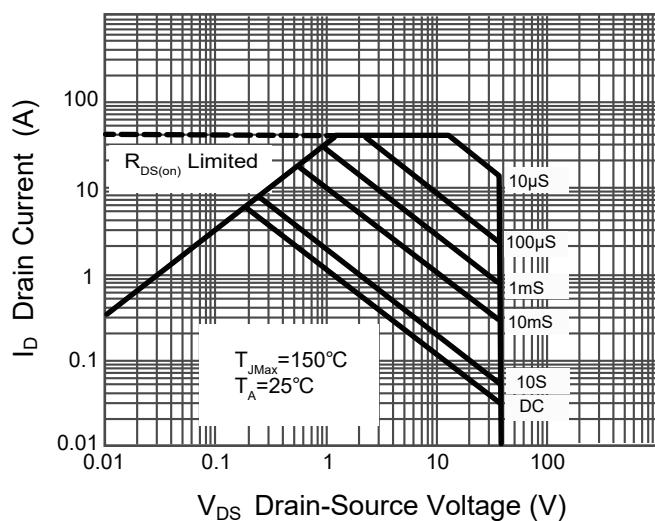
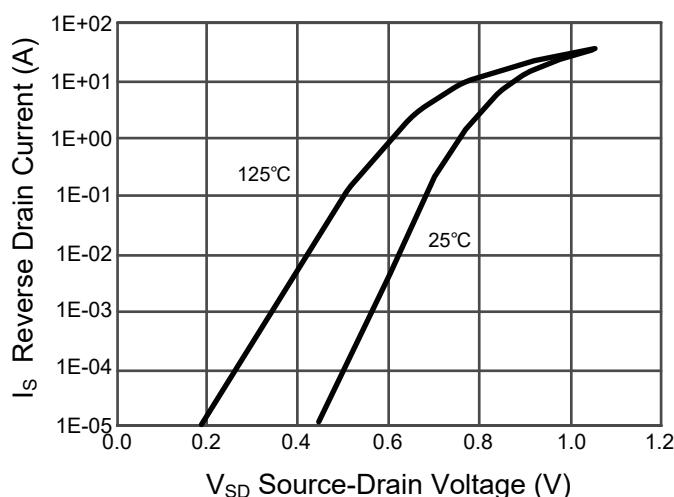
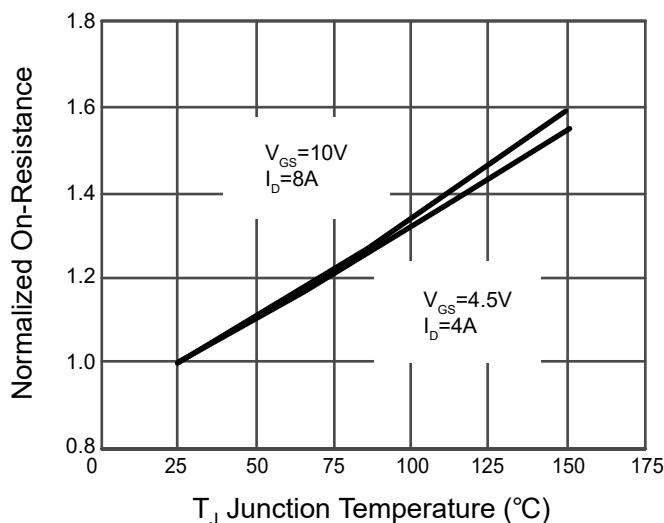
Typical Characteristics Curves

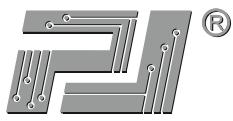




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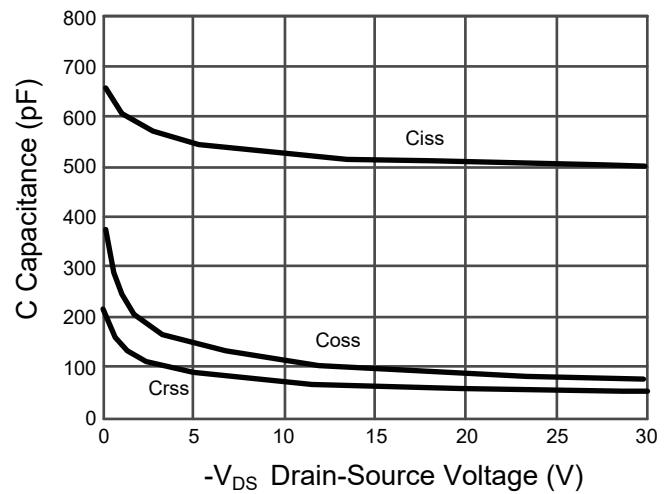
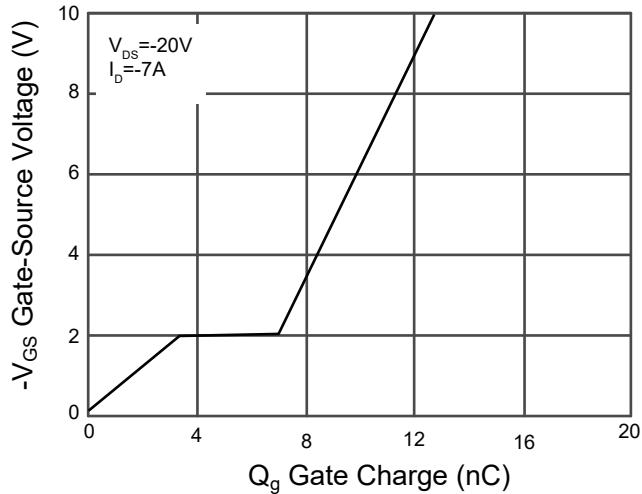
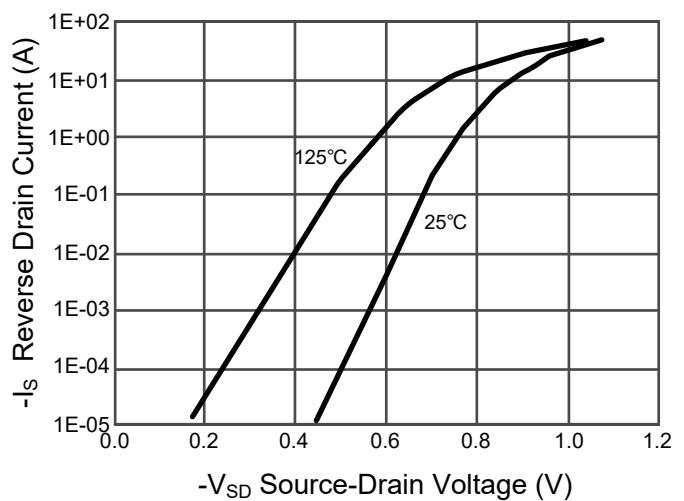
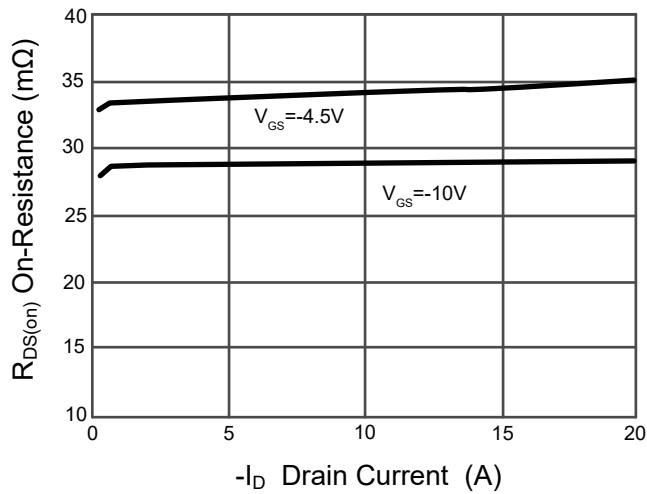
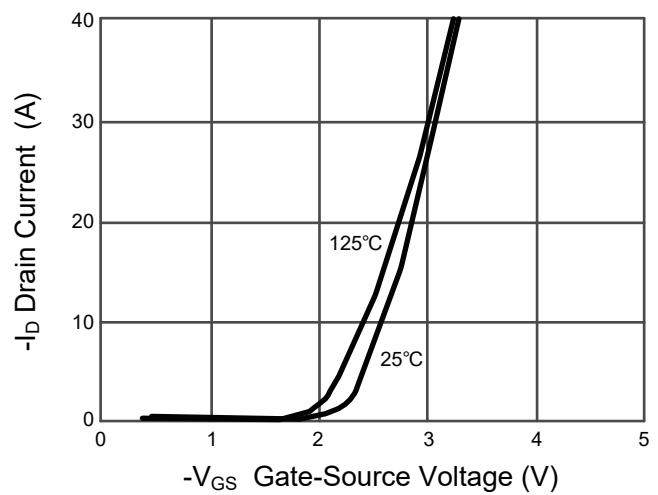
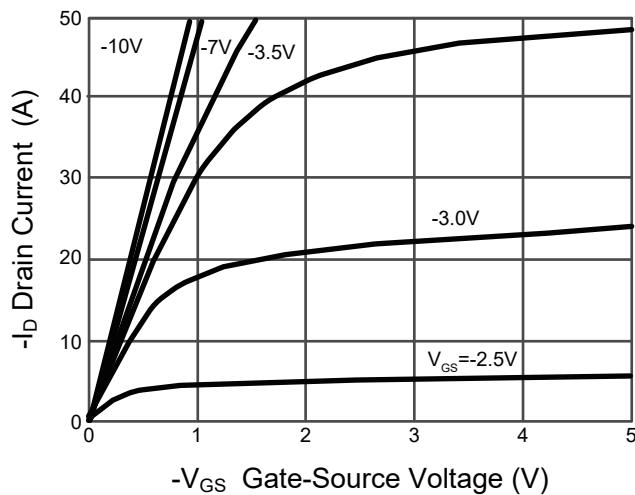


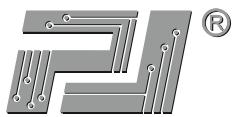
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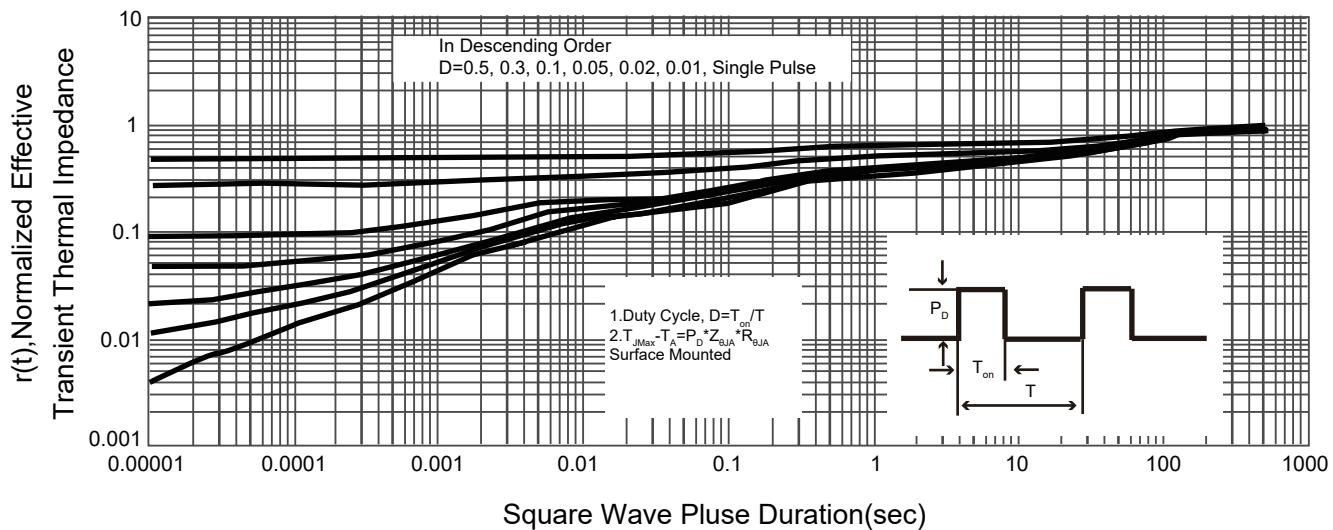
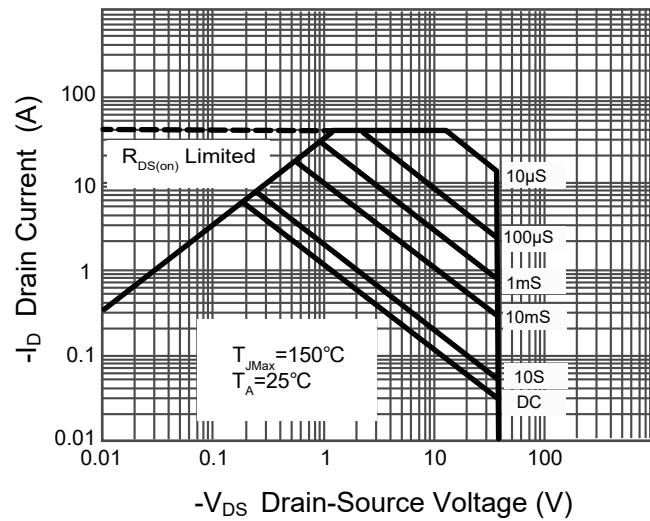
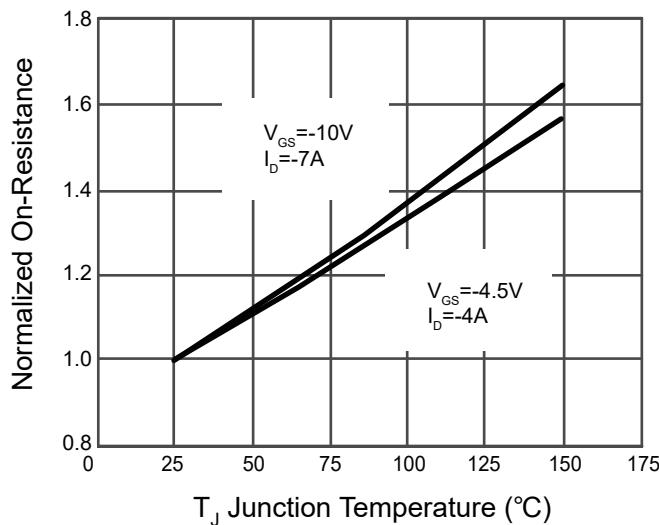
Typical Characteristics Curves





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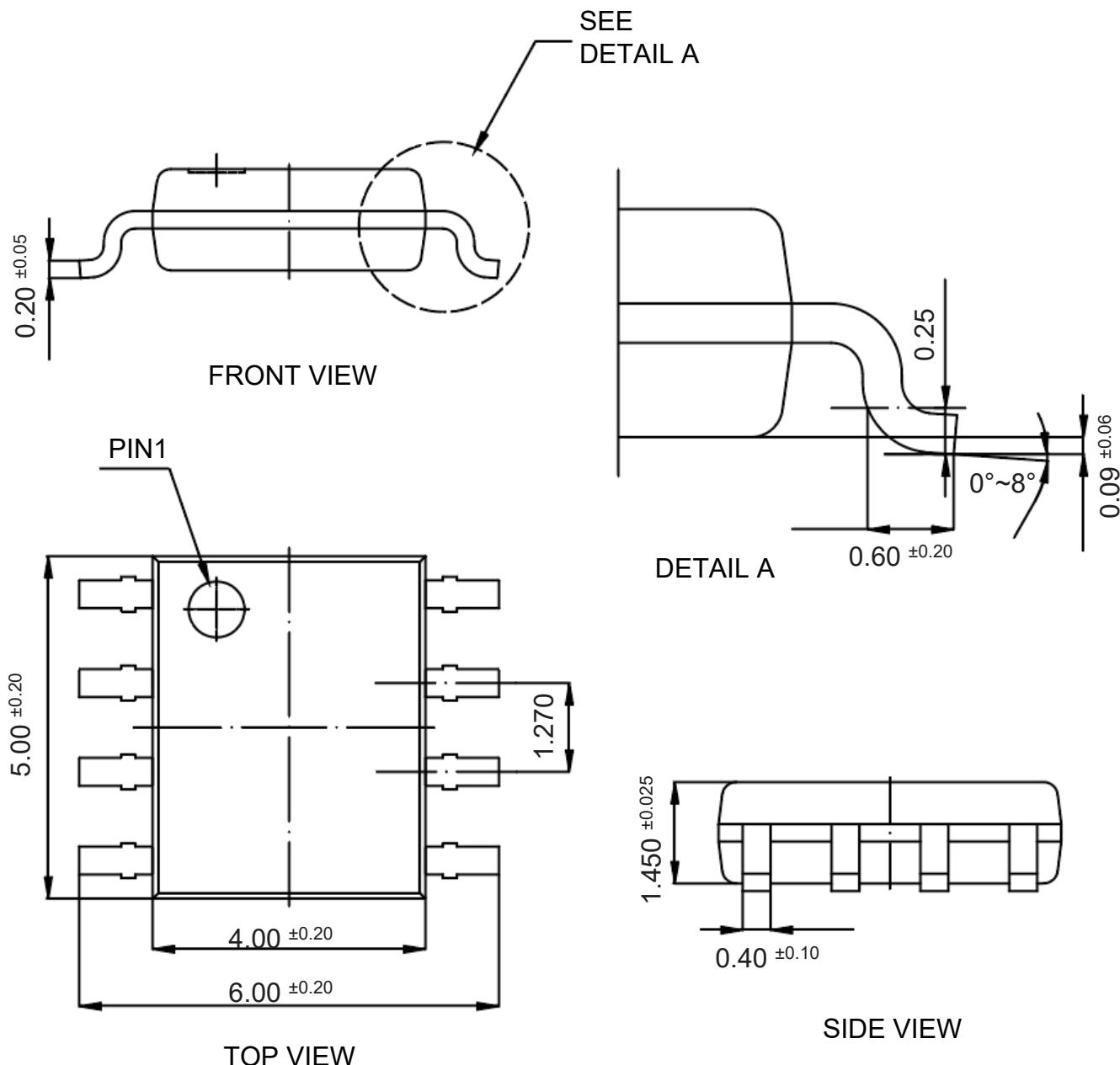
PJM08C40PA

N and P-Channel Complementary Power MOSFET

Package Outline

SOP-8

Dimensions in mm



Ordering Information

Device	Package	Shipping
PJM08C40PA	SOP-8	4,000PCS/Reel&13inches

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